

SCOPE OF ACCREDITATION

Electronics - Printed Board Assemblies

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This certificate expiration is updated based on periodic audits. The current expiration date and scope of accreditation are listed at: www.eAuditNet.com - Online QML (Qualified Manufacturer Listing).

In recognition of the successful completion of the PRI evaluation process, accreditation is granted to this facility to perform the following:

AC7000 Rev A - AUDIT CRITERIA FOR NADCAP ACCREDITATION

AC7120 Rev F - Nadcap Audit Criteria for Printed Board Assemblies (to be used on/AFTER 21-Sep-2025) (CANNOT BE COMBINED WITH AC7119 or AC7121)

Automated Optical Inspection (AOI)

Kitting

Moisture Sensitive Components and Materials

X-Ray

AC7120/2 Rev A - General Soldering of Printed Board Assemblies (to be used on/AFTER 21-Sep-2025)

Build Through / Build Short

Electronic Component Preparation for Preassembly Process

General Soldering of Printed Board Assemblies (Select if no other options apply)

Gold Removal

Hand Soldering

Part Placement: Manual

AC7120/3 Rev A - Plated Through Hole Technology (requires AC7120/2) (to be used on/AFTER 21-Sep-2025)

Selective Soldering

AC7120/4 Rev B - Surface Mount Technology (requires AC7120/2) (to be used on/AFTER 21-Sep-2025)

General Surface Mount Technology (Select if no other options apply)

Solder Paste: Stencil Printing

AC7120/5 Rev A - Mixed Metallurgy for BGAs (requires AC7120/2 and AC7120/4) (to be used

on/AFTER 21-Sep-2025)

Mixed Metallurgy for BGAs

AC7120/6 Rev A - Lead Free Soldering (requires AC7120/2) (to be used on/AFTER 21-Sep-2025)

AC7120/7 Rev B - Conformal Coating of Printed Board Assemblies (to be used on/AFTER 21-Sep-2025)

Conformal Coating of Printed Board Assemblies

AC7120/11 Rev B - Refinishing of Electronic Component (to be used on/AFTER 21-Sep-2025)

Ball Removal

Ball Re-fitting

Flux Paste Application and Reflow Method (No Stencil)

General Refinishing of Electronic Components (select if no other option applies)

Stencil Based Solder or Flux Paste & Reflow Method

AC7120/12 Rev A - Nadcap Audit Criteria for Depaneling (to be used on/AFTER 21-Sep-2025)

Mechanical Router Process